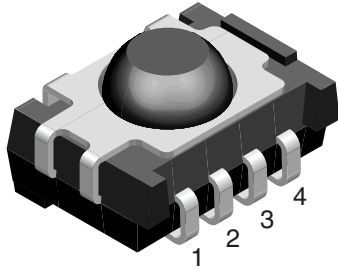




## IR Receiver Modules for Remote Control Systems



16797

### MECHANICAL DATA

#### Pinning:

1 = GND, 2 = N.C., 3 = V<sub>S</sub>, 4 = OUT

### ORDERING CODE

#### Taping:

TSOP36...TT - top view taped

TSOP36...TR - side view taped

### FEATURES

- Very low supply current
- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Continuous data transmission possible
- Supply voltage: 2.5 V to 5.5 V
- Insensitive to supply voltage ripple and noise
- Taping available for topview and sideview assembly
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### DESCRIPTION

The TSOP361.., TSOP363.., and TSOP365.. series are miniaturized SMD IR receiver modules for infrared remote control systems. PIN diode and preamplifier are assembled on a lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can be directly connected to a microprocessor for decoding. The TSOP361.. is a legacy product compatible with all common IR remote control data formats. The TSOP363.. is optimized to better suppress spurious pulses from energy saving fluorescent lamps. The TSOP365.. has an excellent noise suppression. It is immune to dimmed LCD backlighting and any fluorescent lamps. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission. Between these three receiver types, the TSOP363.. is preferred. Customers should initially try the TSOP363.. in their design.

This component has not been qualified according to automotive specifications.

| PARTS TABLE              |        |  |  |   |
|--------------------------|--------|--|--|---|
| AGC                      |        | LEGACY, FOR SHORT BURST REMOTE CONTROLS (AGC1)   | NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3) | VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5) |
| Carrier frequency        | 30 kHz | TSOP36130  | TSOP36330                                  | TSOP36530                                       |
|                          | 33 kHz | TSOP36133  | TSOP36333                                  | TSOP36533                                       |
|                          | 36 kHz | TSOP36136  | TSOP36336 <sup>(1)(2)</sup>                | TSOP36536 <sup>(1)(2)</sup>                     |
|                          | 38 kHz | TSOP36138  | TSOP36338 <sup>(3)(4)(5)(6)</sup>          | TSOP36538 <sup>(3)(4)(5)</sup>                  |
|                          | 40 kHz | TSOP36140  | TSOP36340                                  | TSOP36540                                       |
|                          | 56 kHz | TSOP36156  | TSOP36356                                  | TSOP36556                                       |
| Package                  |        | Panhead  |  |   |
| Pinning                  |        | 1 = GND, 2 = N.C., 3 = V <sub>S</sub> , 4 = OUT  |  |   |
| Dimensions (mm)          |        | 7.5 W x 5.3 H x 4.0 D  |  |   |
| Mounting                 |        | SMD  |  |   |
| Application              |        | Remote control   |  |   |
| Best remote control code |        | <sup>(1)</sup> MCIR <sup>(2)</sup> RCMM <sup>(3)</sup> Mitsubishi <sup>(4)</sup> RECS-80 Code <sup>(5)</sup> r-map <sup>(6)</sup> XMP-1, XMP-2 |  |   |

**BLOCK DIAGRAM**


16839

**APPLICATION CIRCUIT**


17170\_5

$R_1$  and  $C_1$  are recommended for protection against EOS. Components should be in the range of  $33 \Omega < R_1 < 1 \text{ k}\Omega$ ,  $C_1 > 0.1 \mu\text{F}$ .

**ABSOLUTE MAXIMUM RATINGS**

| PARAMETER                   | TEST CONDITION                           | SYMBOL    | VALUE                   | UNIT |
|-----------------------------|--|-----------|-------------------------|------|
| Supply voltage (pin 3)      |  | $V_S$     | -0.3 to +6              | V    |
| Supply current (pin 3)      |  | $I_S$     | 3                       | mA   |
| Output voltage (pin 4)      |  | $V_O$     | -0.3 to ( $V_S + 0.3$ ) | V    |
| Output current (pin 4)      |  | $I_O$     | 5                       | mA   |
| Junction temperature        |  | $T_j$     | 100                     | °C   |
| Storage temperature range   |  | $T_{stg}$ | -25 to +85              | °C   |
| Operating temperature range |  | $T_{amb}$ | -25 to +85              | °C   |
| Power consumption           | $T_{amb} \leq 85 \text{ }^\circ\text{C}$ | $P_{tot}$ | 10                      | mW   |

**Note**

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

**ELECTRICAL AND OPTICAL CHARACTERISTICS** ( $T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified)

| PARAMETER             | TEST CONDITION  | SYMBOL             | MIN. | TYP.     | MAX. | UNIT            |
|-----------------------|---|--------------------|------|----------|------|-----------------|
| Supply current        | $E_v = 0, V_S = 3.3 \text{ V}$  | $I_{SD}$           | 0.27 | 0.35     | 0.45 | mA              |
|                       | $E_v = 40 \text{ klx, sunlight}$  | $I_{SH}$           |      | 0.45     |      | mA              |
| Supply voltage        |   | $V_S$              | 2.5  |          | 5.5  | V               |
| Transmission distance | $E_v = 0$ , test signal see fig. 1, IR diode TSAL6200, $I_F = 200 \text{ mA}$                 | $d$                |      | 45       |      | m               |
| Output voltage low    | $I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$ , test signal see fig. 1                 | $V_{OSL}$          |      |          | 100  | mV              |
| Minimum irradiance    | Pulse width tolerance:<br>$t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see fig. 1 | $E_e \text{ min.}$ |      | 0.12     | 0.25 | $\text{mW/m}^2$ |
| Maximum irradiance    | $t_{pi} - 5/f_o < t_{po} < t_{pi} + 6/f_o$ , test signal see fig. 1                           | $E_e \text{ max.}$ | 30   |          |      | $\text{W/m}^2$  |
| Directivity           | Angle of half transmission distance   | $\phi_{1/2}$       |      | $\pm 50$ |      | deg             |

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)



Fig. 1 - Output Function

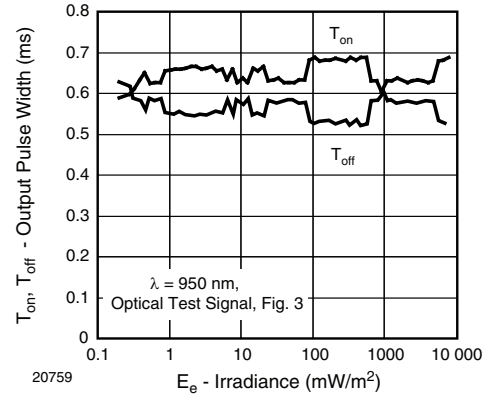


Fig. 4 - Output Pulse Diagram



Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

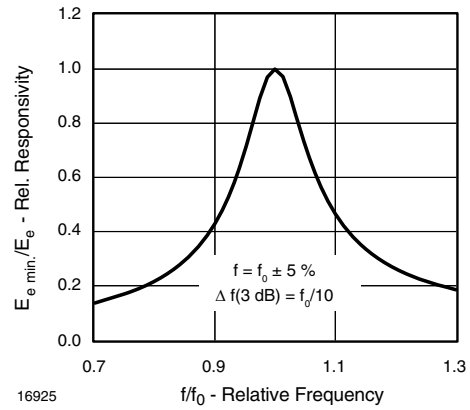


Fig. 5 - Frequency Dependence of Responsivity



Fig. 3 - Output Function

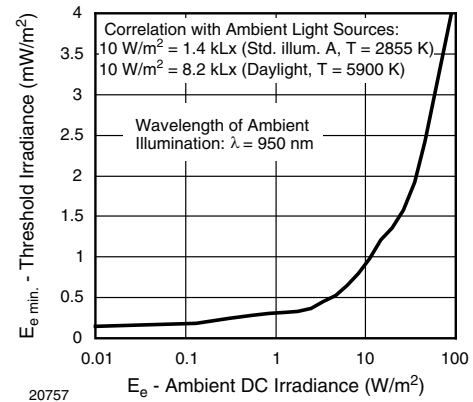


Fig. 6 - Sensitivity in Bright Ambient



Fig. 7 - Sensitivity vs. Supply Voltage Disturbances



Fig. 10 - Relative Spectral Sensitivity vs. Wavelength



Fig. 8 - Maximum Envelope Duty Cycle vs. Burstlength



Fig. 11 - Directivity



Fig. 9 - Sensitivity vs. Ambient Temperature



Fig. 12 - Sensitivity vs. Supply Voltage

**SUITABLE DATA FORMAT**

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see figure 13 or figure 14)



Fig. 13 - IR Disturbance from Fluorescent Lamp with Low Modulation



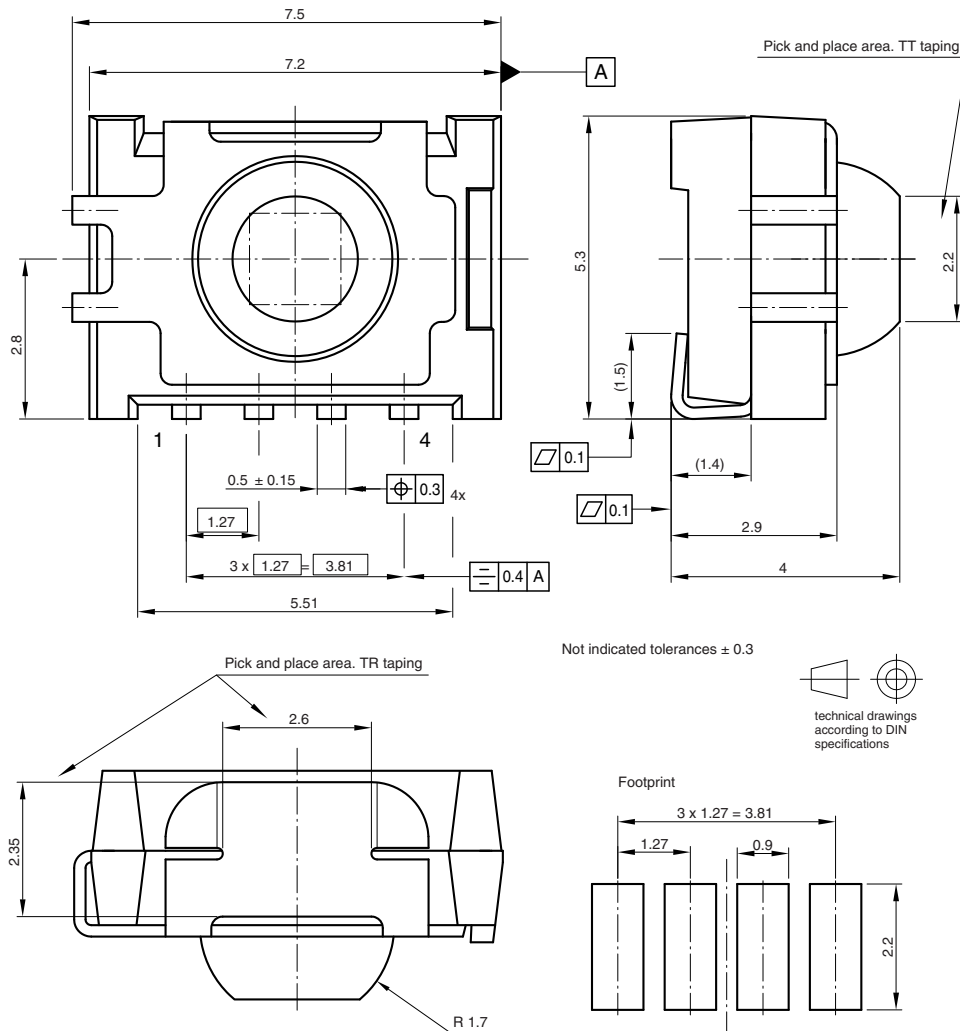
Fig. 14 - IR Disturbance from Fluorescent Lamp with High Modulation

|  | <b>TSOP361..</b>  | <b>TSOP363..</b>  | <b>TSOP365..</b>  |
|--|---|---|---|
| Minimum burst length   | 6 cycles/burst  | 6 cycles/burst  | 6 cycles/burst  |
| After each burst of length A gap time is required of                       | 6 to 70 cycles<br>≥ 10 cycles   | 6 to 35 cycles<br>≥ 10 cycles   | 6 to 24 cycles<br>≥ 10 cycles   |
| For bursts greater than a minimum gap time in the data stream is needed of | 70 cycles<br>> 1.2 x burst length   | 35 cycles<br>> 6 x burst length   | 24 cycles<br>> 25 ms  |
| Maximum number of continuous short bursts/second                           | 2000  | 2000  | 2000  |
| MCIR code  | yes   | preferred   | yes   |
| RCMM code  | yes   | preferred   | yes   |
| XMP-1, XMP-2 code  | yes   | preferred   | yes   |
| Suppression of interference from fluorescent lamps                         | Common disturbance patterns are suppressed (example: signal pattern of fig. 14) | Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15) | Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15) |

**Notes**

- For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP362.., TSOP364..
- Best choice of AGC for some popular IR-codes:
  - TSOP36336, TSOP36536: MCIR, RCMM
  - TSOP36538: Mitsubishi, RECS-80 Code
  - TSOP36338: XMP-1, XMP-2, r-map
- For SIRCS 15 and 20 bit, Sony 12 bit IR-codes, please see the datasheet for TSOP4S40, TSOP2S40

**PACKAGE DIMENSIONS** in millimeters



Drawing-No.: 6.544-5341.01-4  
 Issue: 8; 02.09.09  
 16776

**ASSEMBLY INSTRUCTIONS**

**Reflow Soldering**

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

**Manual Soldering**

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off.



## VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



## TAPING VERSION TSOP..TT DIMENSIONS in millimeters





## TAPING VERSION TSOP..TR DIMENSIONS in millimeters





**REEL DIMENSIONS** in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

**LEADER AND TRAILER DIMENSIONS** in millimeters



**COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3  
 0.1 N to 1.3 N  
 300 mm/min. ± 10 mm/min.  
 165° to 180° peel angle

**LABEL**

**Standard bar code labels for finished goods**

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| <b>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (Finished goods)</b> |                     |               |
|---|---------------------|---------------|
| <b>PLAIN WRITTING</b>   | <b>ABBREVIATION</b> | <b>LENGTH</b> |
| Item-description  | -                   | 18            |
| Item-number   | INO                 | 8             |
| Selection-code  | SEL                 | 3             |
| LOT-/serial-number  | BATCH               | 10            |
| Data-code   | COD                 | 3 (YWW)       |
| Plant-code  | PTC                 | 2             |
| Quantity  | QTY                 | 8             |
| Accepted by   | ACC                 | -             |
| Packed by   | PCK                 | -             |
| Mixed code indicator  | MIXED CODE          | -             |
| Origin  | xxxxxxx+            | Company logo  |
| <b>LONG BAR CODE TOP</b>  | <b>TYPE</b>         | <b>LENGTH</b> |
| Item-number   | N                   | 8             |
| Plant-code  | N                   | 2             |
| Sequence-number   | X                   | 3             |
| Quantity  | N                   | 8             |
| Total length  | -                   | 21            |
| <b>SHORT BAR CODE BOTTOM</b>  | <b>TYPE</b>         | <b>LENGTH</b> |
| Selection-code  | X                   | 3             |
| Data-code   | N                   | 3             |
| Batch-number  | X                   | 10            |
| Filter  | -                   | 1             |
| Total length  | -                   | 17            |

### DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

### RECOMMENDED METHOD OF STORAGE

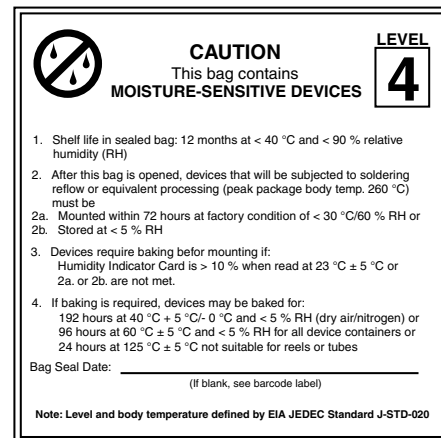
Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:  
 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or  
 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or  
 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags



### ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

### VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



## Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR Receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

### PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

### MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

**Tensile strength** of the tape: > 15 N

### NUMBER OF COMPONENTS

- A. Panhead SMD: quantity per reel:
  - TT, SMD top view package, 1190 pcs
  - TR, SMD side view package, 1120 pcs
- B. Heimdall: quantity per reel:
  - TT, Heimdall top view package, 2200 pcs
  - TR, Heimdall side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel:
  - WTT, top view package, 2200 pcs
  - WTR, side view package, 2300 pcs
- D. Bugeye: quantity per reel:
  - TT, 2500 pcs
  - TR, 2500 pcs
- E. AP5: quantity per reel:
  - TT, 2500 pcs
  - TR, not available in side view
- F. Belobog: quantity per reel:
  - TT1, 1800 pcs
  - TT2, 7000 pcs
  - TR, not available in side view
- G. Belobog with shield: quantity per reel:
  - TT1, 1500 pcs
  - TT2, 5000 pcs

### ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

#### Example:

- TSOP6238TR (reel packing)
- TSOP75238TR (reel packing)
- TSOP75338WTT (reel packing)
- TSOP85438TT (reel packing)
- TSOP85238AP5TR (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)



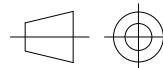
## REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

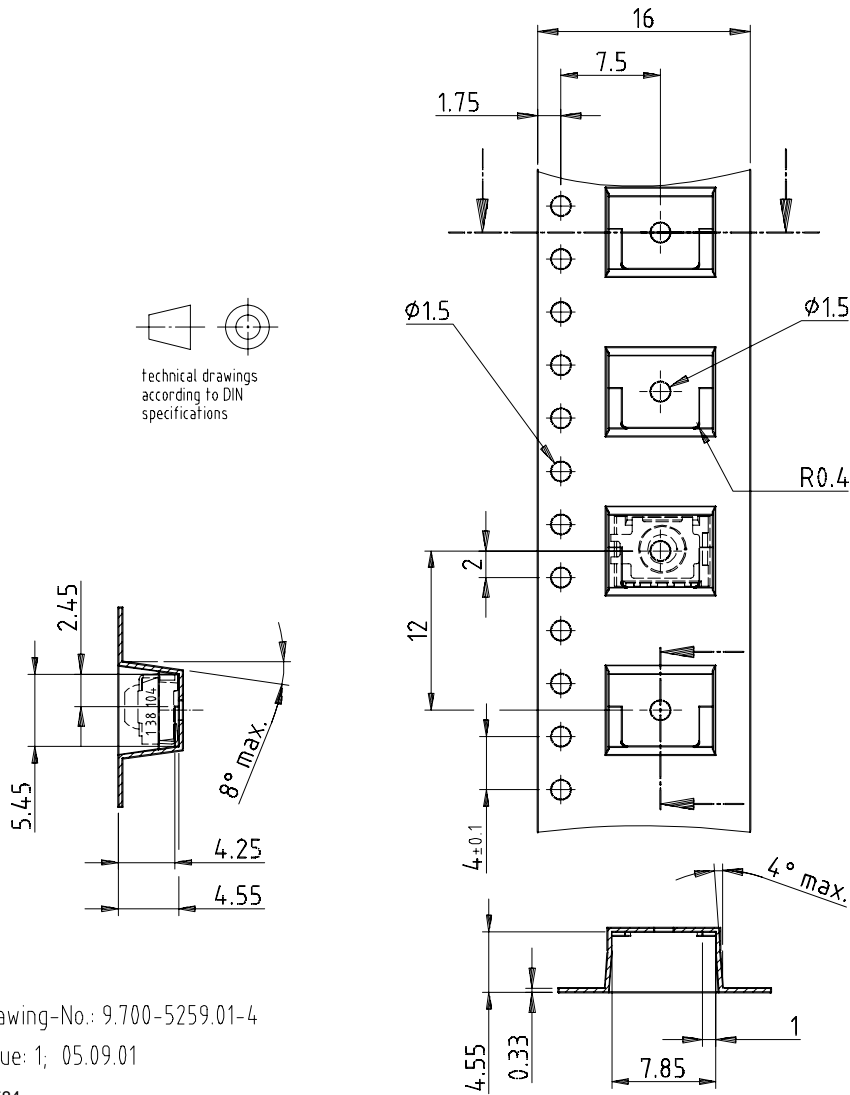
### Note

- The body structure of the reel can vary



### TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TT, TSOP35...TT, TSOP6...TT)



Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

16584



**TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS** in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT)



Drawing-No.: 9.700-5338.01-4  
Issue: 3; 09.06.09  
21578



technical drawings  
according to DIN  
specifications







## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TT)



Drawing-No.: 9.700-5317.01-4

Issue: 2; 10.04.08

20629



## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

E. AP5 (TSOP85...AP5TT)



Drawing-No.: 9.700-5346.01-4  
Issue: 2, 24.11.09  
21945

## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

F. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



Drawing-No.: 9.700-5347.01-4  
 Issue: 1; 14.11.11

Not indicated tolerances  $\pm 0.1$



## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

G. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

### Tape and Reel dimensions:



Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4  
Issue: 1; 28.10.13



### TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead SMD (TSOP36...TR, TSOP35...TR, TSOP6...TR)



Drawing-No.: 9.700-5260.01-4

Issue: 2; 25.09..01

16585

## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

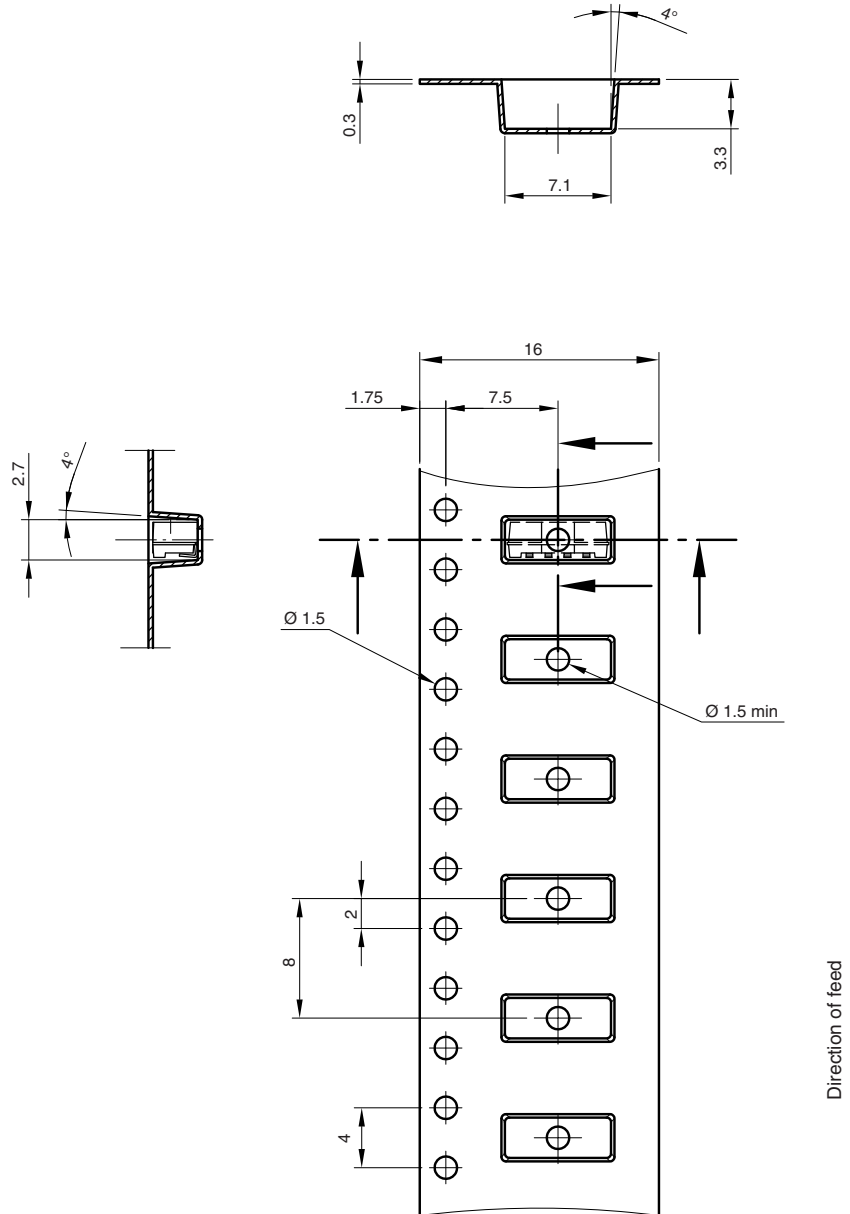
B. Heimdall SMD (TSOP75..., TSOP77...)



Drawing-No.: 9.700-5337.01-4  
 Issue: 1; 16.10.08  
 21577

## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR)



Drawing-No.: 9.700-5342.01-4

Issue: 1: 23.03.09

21785



technical drawings  
according to DIN  
specifications



## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TR)



Drawing-No.: 9.700-5316.01-4

Issue: 1; 12.02.07

20628



### LEADER AND TRAILER DIMENSIONS in millimeters



### COVER TAPE REEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min.  $\pm$  10 mm/min.

165° to 180° peel angle

### LABEL

#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods) |              |              |
|--|--------------|--------------|
| PLAIN WRITING  | ABBREVIATION | LENGTH       |
| Item-description   | -            | 18           |
| Item-number  | INO          | 8            |
| Selection-code   | SEL          | 3            |
| LOT-/serial-number   | BATCH        | 10           |
| Data-code  | COD          | 3 (YWW)      |
| Plant-code   | PTC          | 2            |
| Quantity   | QTY          | 8            |
| Accepted by  | ACC          | -            |
| Packed by  | PCK          | -            |
| Mixed code indicator   | MIXED CODE   | -            |
| Origin   | xxxxxxx+     | Company logo |
| LONG BAR CODE TOP  | TYPE         | LENGTH       |
| Item-number  | N            | 8            |
| Plant-code   | N            | 2            |
| Sequence-number  | X            | 3            |
| Quantity   | N            | 8            |
| Total length   | -            | 21           |
| SHORT BAR CODE TOP   | TYPE         | LENGTH       |
| Selection-code   | X            | 3            |
| Data-code  | N            | 3            |
| Batch-number   | X            | 10           |
| Filter   | -            | 1            |
| Total length   | -            | 17           |

## DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or
- 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
- 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JSTD-020 level 4 label is included on all dry bags.



22522

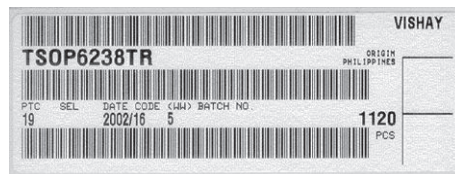
EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



16962

## OUTER PACKAGING

The sealed reel is packed into a pizza box.

| CARTON BOX DIMENSIONS in millimeters                 |           |       |        |
|--|-----------|-------|--------|
|  |           |       |        |
|  | THICKNESS | WIDTH | LENGTH |
| Pizza Box<br>(SMD and Heimdall)<br>(Taping in Reels) | 50        | 340   | 340    |

22127



## Disclaimer

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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